Dual JK Positive Edge-Triggered Flip-Flop

The SN74LS109A consists of two high speed completely independent transition clocked $J\overline{K}$ flip-flops. The clocking operation is independent of rise and fall times of the clock waveform. The $J\overline{K}$ design allows operation as a D flip-flop by simply connecting the J and \overline{K} pins together.

MODE SELECT - TRUTH TABLE

OPERATING MODE		INP	OUTPUTS			
OPERATING MODE	SD	<u>C</u> D	J	K	Q	Q
Set	L	Н	Х	Х	Н	L
Reset (Clear)	Н	L	Χ	Х	L	Н
*Undetermined	L	L	Χ	Χ	Н	Н
Load "1" (Set)	Н	Н	h	h	Н	L
Hold	Н	Н	- 1	h	q	q
Toggle	Н	Н	h		q	q
Load "0" (Reset)	Н	Н	1			Н

^{*} Both outputs will be HIGH while both \overline{S}_D and \overline{C}_D are LOW, but the output states are unpredictable if \overline{S}_D and \overline{C}_D go HIGH simultaneously.

H, h = HIGH Voltage Level

L, I = LOW Voltage Level

X = Don't Care

I, h (q) = Lower case letters indicate the state of the referenced input (or output) one set-up time prior to the LOW to HIGH clock transition.

GUARANTEED OPERATING RANGES

Symbol	Parameter	Min	Typ	Max	Unit
V _{CC}	Supply Voltage	4.75	5.0	5.25	V
T _A	Operating Ambient Temperature Range	0	25	70	°C
I _{OH}	Output Current - High	0.		-0.4	mA
I _{OL}	Output Current - Low			8.0	mA



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LOW POWER SCHOTTKY



PLASTIC N SUFFIX CASE 648



SOIC D SUFFIX CASE 751B



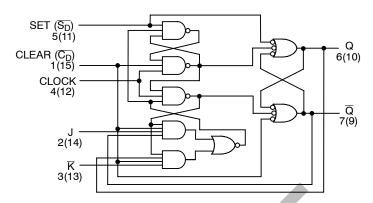
SOEIAJ M SUFFIX CASE 966

ORDERING INFORMATION

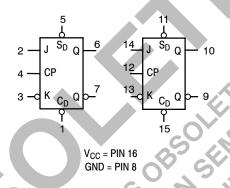
Device	Package	Shipping
SN74LS109AN	16 Pin DIP	2000 Units/Box
SN74LS109AD	SOIC-16	38 Units/Rail
SN74LS109ADR2	SOIC-16	2500/Tape & Reel
SN74LS109AM	SOEIAJ-16	See Note 1
SN74LS109AMEL	SOEIAJ-16	See Note 1

 For ordering information on the EIAJ version of the SOIC package, please contact your local ON Semiconductor representative.

LOGIC DIAGRAM



LOGIC SYMBOL



DC CHARACTERISTICS OVER OPERATING TEMPERATURE RANGE (unless otherwise specified)

			Limits	.117	OX		
Symbol	Parameter	Min	Тур	Max	Unit	Tes	t Conditions
V _{IH}	Input HIGH Voltage	2.0	1		V	Guaranteed Input All Inputs	t HIGH Voltage for
V _{IL}	Input LOW Voltage			0.8	٧	Guaranteed Input All Inputs	t LOW Voltage for
V _{IK}	Input Clamp Diode Voltage		-0.65	-1.5	V	$V_{CC} = MIN, I_{IN} =$	–18 mA
V _{OH}	Output HIGH Voltage	2.7	3.5		٧	V_{CC} = MIN, I_{OH} = or V_{IL} per Truth T	
.,	O to HOWWING		0.25	0.4	V	I _{OL} = 4.0 mA	V _{CC} = V _{CC} MIN,
V _{OL}	Output LOW Voltage		0.35	0.5	V	I _{OL} = 8.0 mA	$V_{IN} = V_{IL}$ or V_{IH} per Truth Table
I _{IH}	Input HIGH Current J, K, Clock Set, Clear			20 40	μΑ	V _{CC} = MAX, V _{IN}	= 2.7 V
	J, K, Clock Set, Clear			0.1 0.2	mA	V _{CC} = MAX, V _{IN}	= 7.0 V
I _{IL}	Input LOW Current J, K, Clock Set, Clear			-0.4 -0.8	mA	V _{CC} = MAX, V _{IN}	= 0.4 V
I _{OS}	Output Short Circuit Current (Note 1)	-20		-100	mA	V _{CC} = MAX	
I _{CC}	Power Supply Current			8.0	mA	V _{CC} = MAX	

Note 1: Not more than one output should be shorted at a time, nor for more than 1 second.

AC CHARACTERISTICS ($T_A = 25$ °C, $V_{CC} = 5.0 \text{ V}$)

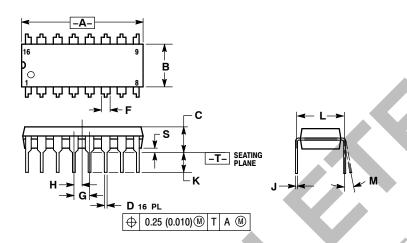
		Limits				
Symbol	Parameter	Min	Тур	Max	Unit	Test Conditions
f _{MAX}	Maximum Clock Frequency	25	33		MHz	
t _{PLH}	Clock, Clear, Set to Output		13	25	ns	$V_{CC} = 5.0 \text{ V}$ $C_1 = 15 \text{ pF}$
t _{PHL}	Clock, Clear, Set to Output		25	40	ns	-L P.

AC SETUP REQUIREMENTS ($T_A = 25$ °C, $V_{CC} = 5.0 \text{ V}$)

	Т		Limits			
Symbol	Parameter	Min	Тур	Max	Unit	Test Conditions
t _W	Clock High Clear, Set Pulse Width	25			ns	
t _s	Data Setup Time — HIGH	20			ns	V _{CC} = 5.0 V
^L S	LOW	20			ns	
t _h	Hold time	5.0			ns	
	CS CONTRACTOR OF THE PROPERTY	OE SE		JR JR	SOL SOL	FIE OND TON HICOMORION NEO PHINTION

PACKAGE DIMENSIONS

N SUFFIX PLASTIC PACKAGE CASE 648-08 **ISSUE R**



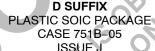
NOTES:

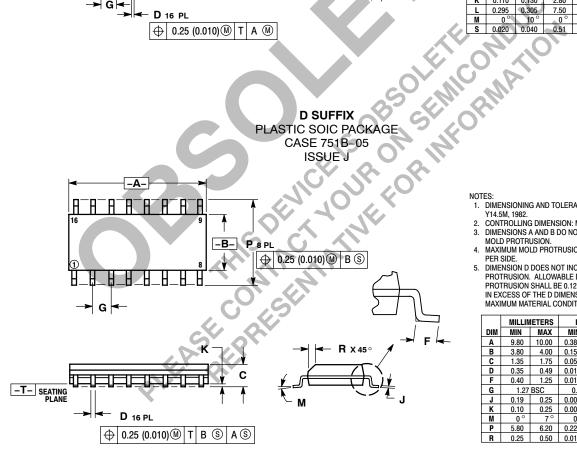
- DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
- CONTROLLING DIMENSION: INCH.
 DIMENSION L TO CENTER OF LEADS WHEN FORMED PARALLEL

 DIMENSION B DOES NOT INCLUDE MOLD FLASH.

 ROUNDED CORNERS OPTIONAL.

	INC	HES	MILLIN	IETERS	
DIM	MIN	MAX	MIN	MAX	
A	0.740	0.770	18.80	19.55	
B	0.250	0.270	6.35	6.85	
O	0.145	0.175	3.69	4.44	
D	0.015	0.021	0.39	0.53	
F	0.040	0.70	1.02	1.77	
G	0.100	BSC	2.54 BSC		
Н	0.050	BSC	1.27 BSC		
J	0.008	0.015	0.21	0.38	
K	0.110	0.130	2.80	3.30	
L	0.295	0.305	7.50	7.74	
M	0 0	10°	_0°	10°	
S	0.020	0.040	0.51	1.01	





- 1. DIMENSIONING AND TOLERANCING PER ANSI DIMENSIONING AND TOLERANCING PER ANY 14.5M, 1982.
 CONTROLLING DIMENSION: MILLIMETER. DIMENSIONS A AND B DO NOT INCLUDE MOLD PROTRUSION.
 MAXIMUM MOLD PROTRUSION 0.15 (0.006) PER SIDE.

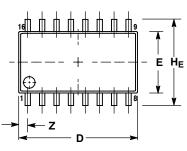
- PER SIDE.
 DIMENSION D DOES NOT INCLUDE DAMBAR
 PROTRUSION. ALLOWABLE DAMBAR
 PROTRUSION SHALL BE 0.127 (0.005) TOTAL
 IN EXCESS OF THE D DIMENSION AT
 MAXIMUM MATERIAL CONDITION.

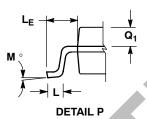
	MILLIN	IETERS	INCHES		
DIM	MIN	MAX	MIN	MAX	
Α	9.80	10.00	0.386	0.393	
В	3.80	4.00	0.150	0.157	
С	1.35	1.75	0.054	0.068	
D	0.35	0.49	0.014	0.019	
F	0.40	1.25	0.016	0.049	
G	1.27	BSC	0.050 BSC		
J	0.19	0.25	0.008	0.009	
K	0.10	0.25	0.004	0.009	
M	0°	7°	0°	7°	
Р	5.80	6.20	0.229	0.244	
R	0.25	0.50	0.010	0.019	

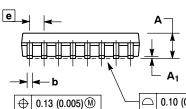
PACKAGE DIMENSIONS

M SUFFIX

SOEIAJ PACKAGE CASE 966-01 ISSUE O









NOTES:

- DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
- 2. CONTROLLING DIMENSION: MILLIMETER
- 3. DIMENSIONS D AND E DO NOT INCLUDE MOLD FLASH OR PROTRUSIONS AND ARE MEASURED AT THE PARTING LINE. MOLD FLASH OR PROTRUSIONS SHALL NOT EXCEED 0.15 (0.006) PER SIDE.
- 4. TERMINAL NUMBERS ARE SHOWN FOR
- REFERENCE ONLY.

 5. THE LEAD WIDTH DIMENSION (b) DOES NOT INCLUDE DAMBAR PROTRUSION. ALLOWABLE DAMBAR PROTRUSION SHALL BE 0.08 (0.003) TOTAL IN EXCESS OF THE LEAD WIDTH DIMENSION AT MAXIMUM MATERIAL CONDITION. DAMBAR CANNOT BE LOCATED ON THE LOWER RADIUS OR THE FOOT. MINIMUM SPACE BETWEEN PROTRUSIONS AND ADJACENT LEAD TO BE 0.46 (0.018).

	MILLIMETERS		INC	HES	
DIM	MIN	MAX	MIN	MAX	
Α		2.05	-14	0.081	
Α1	0.05	0.20	0.002	0.008	
ь	0.35	0.50	0.014	0.020	
C	0.18	0.27	0.007	0.011	
D	9.90	10.50	0.390	0.413	
E	5.10	5.45	0.201	0.215	
e	1.27	BSC	0.050 BSC		
HE	7.40	8.20	0.291	0.323	
L	0.50	0.85	0.020	0.033	
LΕ	1.10	1.50	0.043	0.059	
M	0 °	10°	0°	10°	
Q ₁	0.70	0.90	0.028	0.035	
Z		0.78		0.031	

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